

# R1WV3216R Series

32Mb Advanced LPSRAM (2M wordx16bit)

REJ03C0215-0300Z Rev.3.00 2008.03.03

## **Description**

The R1WV3216R Series is a family of low voltage 32-Mbit static RAMs organized as 2097152-words by 16-bit, fabricated by Renesas's high-performance 0.15um CMOS and TFT technologies.

The R1WV3216R Series is suitable for memory applications where a simple interfacing, battery operating and battery backup are the important design objectives.

The R1WV3216R Series is made by stacked-micro-package technology and two chips of 16Mbit Advanced LPSRAMs are assembled in one package.

The R1WV3216R Series is packaged in a 52pin micro thin small outline mount device[ $\mu$ TSOP / 10.79mm x 10.49mm with the pin-pitch of 0.4mm] or a 48balls fine pitch ball grid array [f-BGA / 7.5mmx8.5mm with the ball-pitch of 0.75mm and 6x8 array] . It gives the best solution for a compaction of mounting area as well as flexibility of wiring pattern of printed circuit boards.

### **Features**

- Single 2.7-3.6V power supply
- Small stand-by current:4µA (3.0V, typ.)
- Data retention supply voltage =2.0V
- · No clocks, No refresh
- All inputs and outputs are TTL compatible.
- Easy memory expansion by CS1#, CS2, LB# and UB#
- Common Data I/O
- Three-state outputs: OR-tie capability
- OE# prevents data contention on the I/O bus
- Process technology: 0.15um CMOS



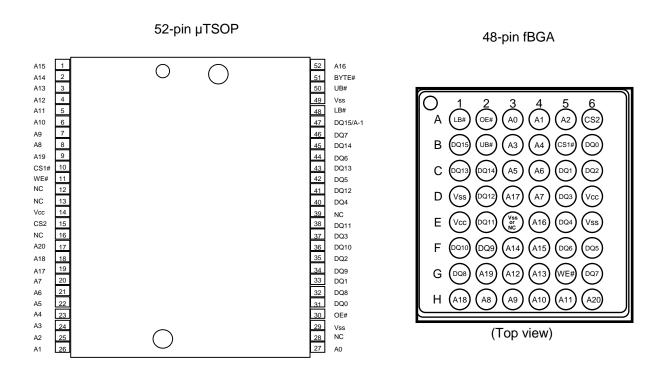
# **Ordering Information**

Type No.	Access time	Package
R1WV3216RSD-7S%	70 ns	350-mil 52-pin plastic μ - TSOP(II)
R1WV3216RSD-8S%	85 ns	(normal-bend type) (52PTG)
R1WV3216RBG-7S%	70 ns	7 Emmy 9 Emm f DCA 0.75mm pitch 49hall
R1WV3216RBG-8S%	85 ns	7.5mmx8.5mm f-BGA 0.75mm pitch 48ball

% - Temperature version; see table below

%	Temperature Range
R	0 ~ +70 °C
ı	-40 ~ +85 °C

## **Pin Arrangement**

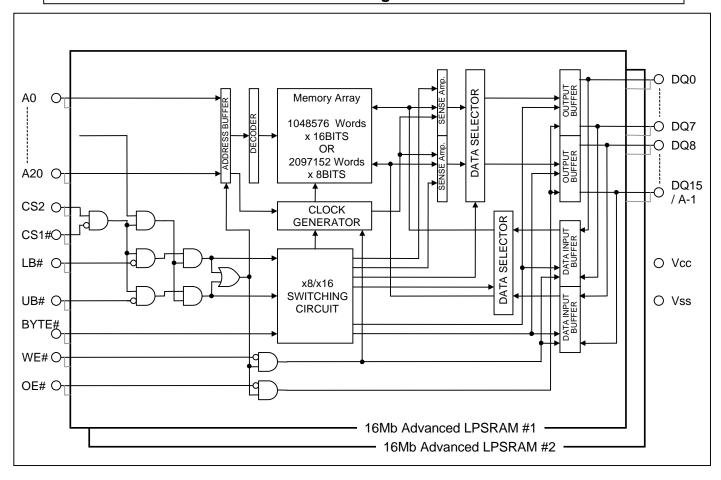


Pin Description					
Pin name	Function				
A0 to A20	Address input (Word mode)				
A-1 to A20	Address input (Byte mode)				
DQ 0 to DQ15	Data input/output				
CS1# &CS2	Chip select				
WE#	Write enable				
OE#	Output enable				
LB#	Lower byte select				
UB#	Upper byte select				
Vcc	Power supply				
Vss	Ground				
BYTE#	Byte (x8 mode) enable input				
NC	Non connection				

Note: Byte Mode is supported by only 52-pin  $\mu$ TSOP type.



## **Block Diagram**



Note: BYTE# pin is supported by only 52-pin  $\mu$ TSOP type.

## **Operating Table**

CS1#	CS2	BYTE#	LB#	UB#	WE#	OE#	DQ0-7	DQ8-14	DQ15	Operation
Н	Х	Х	Х	Х	Х	Х	High-Z	High-Z	High-Z	Stand by
Х	L	Х	Х	Х	Х	Х	High-Z	High-Z	High-Z	Stand by
Х	Х	Н	Н	Н	Х	Х	High-Z	High-Z	High-Z	Stand by
L	Н	Н	L	Н	L	Х	Din	High-Z	High-Z	Write in lower byte
L	Н	Н	L	Н	Н	L	Dout	High-Z	High-Z	Read from lower byte
L	Н	Х	Х	Х	Н	Н	High-Z	High-Z	High-Z	Output disable
L	Н	Н	Н	L	L	Х	High-Z	Din	Din	Write in upper byte
L	Н	Н	Н	L	Н	L	High-Z	Dout	Dout	Read from upper byte
L	Н	Н	L	L	L	Х	Din	Din	Din	Write
L	Н	Н	L	L	Н	L	Dout	Dout	Dout	Read
L	Н	L	L	L	L	Х	Din	High-Z	A-1	Write
L	Н	L	L	L	Н	L	Dout	High-Z	A-1	Read

Note 1. H:VIH L:VIL X: VIH or VIL

## **Absolute Maximum Ratings**

Parameter	Symbol		Unit	
Power supply voltage relative to Vss	Vcc	-0.5 to +4.6		V
Terminal voltage on any pin relation toVss	VT	-0.5	*1 to Vcc+0.3*2	V
Power dissipation	Рт		0.7	W
Operation tomperature	Tonr	R ver. *3	0 to +70	°C
Operation temperature	Topr	I ver. *3	-40 to +85	°C
Storage temperature	Tstg		-65 to +150	°C
Storage temperature range under high	Tbias	R ver. *3	0 to +70	°C
Storage temperature range under bias	Tulas	l ver. *3	-40 to +85	°C

Note 1: -2.0V in case of AC (Pulse width  $\leq$  30ns)

2: Maximum voltage is +4.6V

3: Temperature range depends on R/I-version. Please see table on page 2.



<sup>2.</sup> BYTE# pin is supported by only 52-pin μTSOP type. When apply BYTE# ="L", please assign LB#=UB#="L".

## **Recommended Operating Conditions**

Parameter	Parameter		Min.	Тур.	Max.	Unit	Note
Supply voltage	0 1 1		2.7	3.0	3.6	V	
Supply voltage		Vss	0	0	0	V	
Input high voltage		VIH	2.4	-	Vcc+0.2	V	
Input low voltage		VIL	-0.2	-	0.4	V	1
Ambient temperature range	R ver.	To	0	-	+70	°C	2
Ambient temperature range	I ver.	Та	-40	-	+85	°C	2

Note 1. –2.0V in case of AC (Pulse width  $\leq$  30ns)

## **DC Characteristics**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions*3
Input leakage current	lu			1	μΑ	Vin=Vss to Vcc
Output leakage current	l <sub>Lo</sub>	ı	ı	1	μΑ	BYTE# $\geq$ Vcc-0.2V or BYTE# $\leq$ 0.2V, CS1# =VIH or CS2=VIL or OE# = VIH or WE# =VIL or LB# =UB# =VIH,VI/O=Vss to Vcc
A. coro no on orotin o	Icc <sub>1</sub>		30 *1	55	mA	BYTE# $\geq$ Vcc-0.2V or BYTE# $\leq$ 0.2V, Min. cycle, duty =100% I I/O = 0 mA, CS1# =VIL, CS2=VIH Others = VIH / VIL
Average operating current	lcc2	-	3 *1	8	mA	BYTE# $\geq$ Vcc-0.2V or BYTE# $\leq$ 0.2V, Cycle time = 1 $\mu$ s, I I/O = 0 mA, CS1# $\leq$ 0.2V, CS2 $\geq$ VCC-0.2V VIH $\geq$ VCC-0.2V , VIL $\leq$ 0.2V, duty=100%
Standby current	Isb	ı	0.1 *1	0.3	mA	BYTE# ≥Vcc-0.2V or BYTE#≤0.2V, CS2=VIL
		ı	4 *1	12	μΑ	~+25°C V in ≥ 0V, BYTE# ≥Vcc-0.2V or
		ı	7 *2	24	μΑ	~+40°C BYTE#≤0.2V, (1) 0V≤CS2≤0.2V or (2) CS2≥Vcc-0.2V,
Standby current	Isb1	1	ı	50	μA	~+70°C (2) CS2≥VC-0.2V, CS1# ≥Vcc-0.2V or (3)LB# =UB# ≥Vcc-0.2V, CS2≥Vcc-0.2V,
		ı	ı	80	μΑ	~+85°C CS1# ≤0.2V Average value
Output high voltage	Vон	2.4	-	-	V	BYTE# ≥Vcc-0.2V or BYTE#≤0.2V, IOH = -1mA
Output Low voltage	Vol	1	-	0.4	V	BYTE# ≥Vcc-0.2V or BYTE#≤0.2V, IOL = 2mA

Note 1. Typical parameter indicates the value for the center of distribution at Vcc=3.0V (Ta= 25°C), and not 100% tested.

<sup>3.</sup> BYTE# pin is supported by only 52-pin  $\mu$ TSOP type.



<sup>2.</sup> Ambient temperature range depends on R/I-version. Please see table on page 2.

<sup>2.</sup> Typical parameter indicates the value for the center of distribution at Vcc=3.0V (Ta=  $40^{\circ}C$ ), and not 100% tested.

## Capacitance

 $(Ta = +25^{\circ}C, f = 1MHz)$ 

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions	Note
Input capacitance	C in	-	-	20	pF	V in = 0V	1
Input / output capacitance	C 1/0	-	-	20	pF	V I/O = 0V	1

Note 1. This parameter is sampled and not 100% tested.

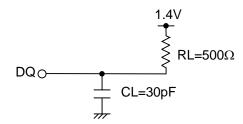
## **AC Characteristics**

Test Conditions (Vcc= $2.7 \sim 3.6 \text{V}$ , Ta =  $0 \sim +70 ^{\circ}\text{C} / -40 \sim +85 ^{\circ}\text{C}$ \*)

• Input pulse levels: VIL= 0.4V,VIH=2.4V

• Input rise and fall time: 5ns

Input and output timing reference levels: 1.4V
Output load: See figures (Including scope and jig)



Note: Temperature range depends on R/I-version. Please see table on page 2.



# **Read Cycle**

Doromotor	Cumbal	R1WV32	16R**-7S	R1WV32	16R**-8S	Unit	Notes
Parameter	Symbol	Min.	Max.	Min.	Max.	Offic	Notes
Read cycle time	<b>t</b> RC	70	-	85	-	ns	
Address access time	<b>t</b> AA	-	70	-	85	ns	
Chin coloct access time	<b>t</b> ACS1	-	70	-	85	ns	
Chip select access time	<b>t</b> ACS2	-	70	1	85	ns	
Output enable to output valid	<b>t</b> oe	-	35	-	45	ns	
Output hold from address change	<b>t</b> он	10	-	10	-	ns	
LB#,UB# access time	<b>t</b> BA	-	70	-	85	ns	
Chip select to output in low-Z	<b>t</b> clz	10	-	10	-	ns	2,3
LB#,UB# enable to low-Z	<b>t</b> BLZ	5	-	5	-	ns	2,3
Output enable to output in low-Z	<b>t</b> olz	5	-	5	-	ns	2,3
Chin decelerate output in high 7	<b>t</b> CHZ1	0	25	0	30	ns	1,2,3
Chip deselect to output in high-Z	<b>t</b> CHZ2	0	25	0	30	ns	1,2,3
LB#,UB# disable to high-Z	<b>t</b> BHZ	0	25	0	30	ns	1,2,3
Output disable to output in high-Z	<b>t</b> onz	0	25	0	30	ns	1,2,3



## **Write Cycle**

Parameter	Symbol	R1WV32	16R**-7S	R1WV32	16R**-8S	Unit	Notes
Parameter	Symbol	Min.	Max.	Min.	Max.	Unit	notes
Write cycle time	<b>t</b> wc	70	-	85	-	ns	
Address valid to end of write	<b>t</b> aw	65	-	70	-	ns	
Chip selection to end of write	<b>t</b> cw	65	-	70	-	ns	5
Write pulse width	twp	55	-	60	-	ns	4
LB#,UB# valid to end of write	<b>t</b> <sub>BW</sub>	65	-	70	-	ns	
Address setup time	<b>t</b> as	0	-	0	-	ns	6
Write recovery time	twr	0	-	0	-	ns	7
Data to write time overlap	tow	35	-	40	-	ns	
Data hold from write time	<b>t</b> DH	0	-	0	-	ns	
Output active from end of write	tow	5	-	5	-	ns	2
Output disable to output in high-Z	<b>t</b> onz	0	25	0	30	ns	1,2
Write to output in high-Z	<b>t</b> wHz	0	25	0	30	ns	1,2

## Byte Enable (supported by only 52-pin µTSOP)

Parameter	Symbol	R1WV32	16R**-7S	R1WV32	16R**-8S	Unit	Notes
Farameter	Symbol	Min.	Max.	Min.	Max.	Offic	Notes
Byte setup time	<b>t</b> BS	5	ı	5	ı	ms	
Byte recovery time	<b>t</b> BR	5	ı	5	ı	ms	

Note 1. tchz, tohz, twhz and tbhz are defined as the time at which the outputs achieve the open circuit conditions and are not referred to output voltage levels.

- 2. This parameter is sampled and not 100% tested.
- 3. AT any given temperature and voltage condition, thz max is less than tLz min both for a given device and form device to device.
- 4. A write occurs during the overlap of a low CS1#, a high CS2, a low WE# and a low LB# or a low UB#. A write begins at the latest transition among CS1# going low, CS2 going high, WE# going low and LB# going low or UB# going low.
  - A write ends at the earliest transition among CS1# going high, CS2 going low, WE# going high and LB# going high or UB# going high. twp is measured from the beginning of write to the end of write.
- 5. tcw is measured from the later of CS1# going low or CS2 going high to end of write.
- 6. tas is measured the address valid to the beginning of write.
- 7. twn is measured from the earliest of CS1# or WE# going high or CS2 going low to the end of write cycle.

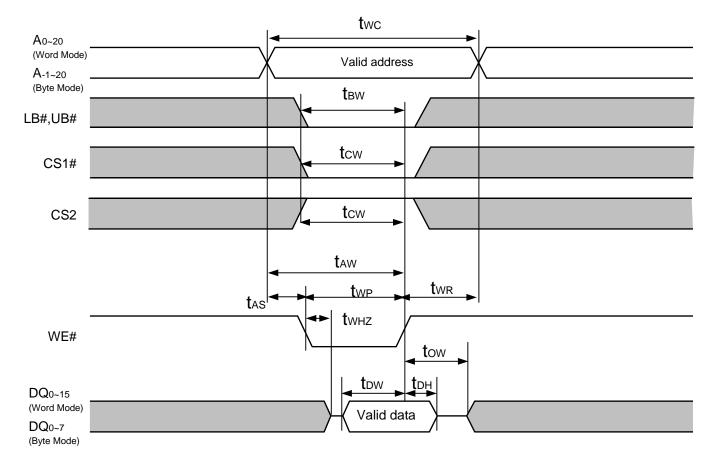


### **Timing Waveform Read Timing Waveform t**RC A0~20 (Word Mode) Valid address A-1~20 **t**AA **t**он (Byte Mode) **t**BA LB#,UB# **t**BHZ t<sub>ACS1</sub> CS1# t<sub>CHZ1</sub> t<sub>ACS2</sub> CS2 tcHZ2 **t**oE OE# tolz\_ **t**onz WE# = "H" level **t**clz DQ<sub>0~15</sub> (Word Mode) **t**BLZ Valid data DQ<sub>0~7</sub> (Byte Mode)

Note: Byte Mode is supported by only 52-pin  $\mu$ TSOP type. BYTE#  $\geq$  Vcc-0.2V or BYTE#  $\leq$  0.2V

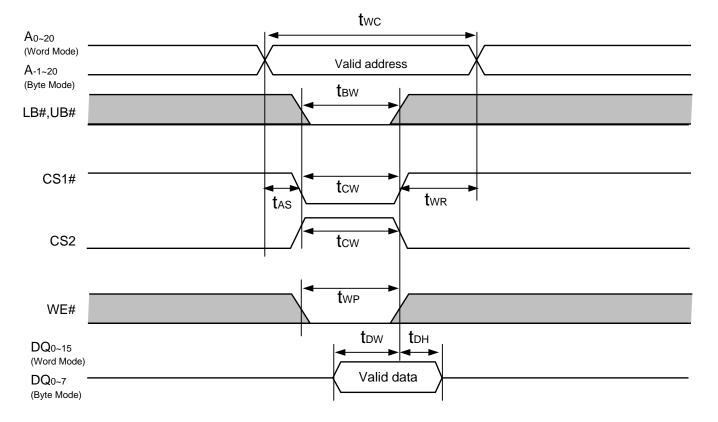


## Write Timing Waveform (1) (WE# CLOCK)



Note: Byte Mode is supported by only 52-pin  $\mu$ TSOP type. BYTE#  $\geq$  Vcc-0.2V or BYTE#  $\leq$  0.2V

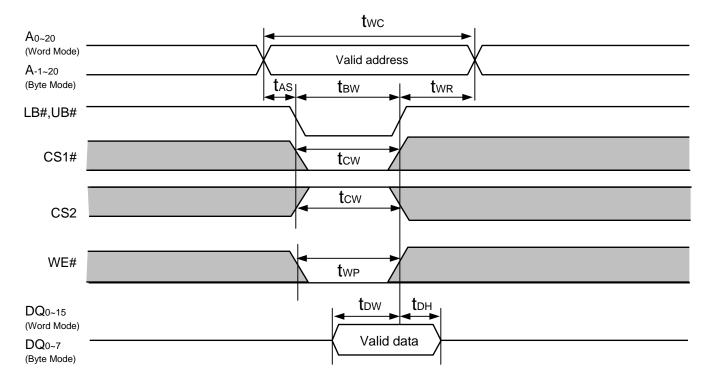
## Write Timing Waveform (2) (CS1#, CS2 CLOCK, OE#=VIH)



Note: Byte Mode is supported by only 52-pin  $\mu$ TSOP type. BYTE#  $\geq$  Vcc-0.2V or BYTE#  $\leq$  0.2V

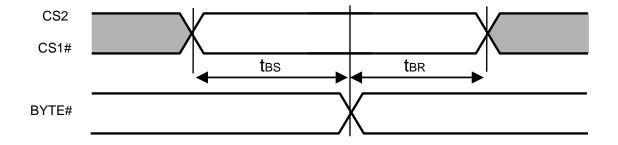


# Write Timing Waveform (3) (LB#,UB# CLOCK, OE#=VIH)



Note: Byte Mode is supported by only 52-pin  $\mu$ TSOP type. BYTE#  $\geq$  Vcc-0.2V or BYTE#  $\leq$  0.2V

## **BYTE# Timing Waveform**





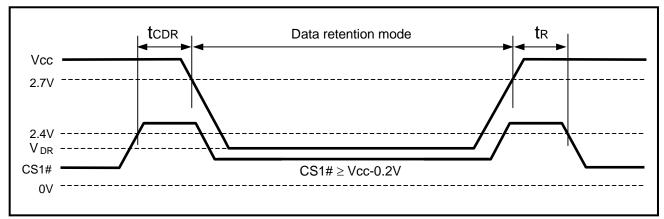
## **Data Retention Characteristics**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Te	st conditions*3,4
Vcc for data retention	Vdr	2.0	-	3.6	V	$\begin{split} &V \text{ in } \ge \text{ OV}, \\ &\text{BYTE} \# \ge \text{Vcc-0.2V or BYTE} \# \le \text{0.2V} \\ &(1) \text{ OV } \le \text{CS2} \le \text{0.2V or} \\ &(2) \text{ CS2} \ge \text{Vcc-0.2V}, \\ &\text{CS1} \# \ge \text{Vcc-0.2V or} \\ &(3) \text{ LB} \# = \text{UB} \# \ge \text{Vcc-0.2V}, \\ &\text{CS2} \ge \text{Vcc-0.2V}, \\ &\text{CS1} \# \le \text{0.2V} \end{split}$	
	<b>Icc</b> dr	I	4 *1	12	μΑ	~+25°C	Vcc=3.0V,Vin≥0V, BYTE# ≥ Vcc-0.2V or
		-	7 *2	24	μΑ	~+40°C	BYTE# ≤ 0.2V (1) 0V ≤ CS2 ≤ 0.2V or (2) CS2 ≥ Vcc-0.2V,
Data retention current		-	-	50	μΑ	~+70°C	(2) C32 ≥ V6C-0.2V, CS1# ≥ Vcc-0.2V or (3) LB# =UB# ≥Vcc-0.2V,
		1	-	80	μA	~+85°C	CS2 ≥ Vcc-0.2V, CS1# ≤ 0.2V Average value
Chip deselect to data retention time	tcdr	0	-	-	ns	See retention waveform	
Operation recovery time	<b>t</b> R	5	-	-	ms		

- Note 1. Typical parameter indicates the value for the center of distribution at Vcc=3.0V ( $Ta=25^{\circ}C$ ) and not 100% tested.
  - 2. Typical parameter indicates the value for the center of distribution at Vcc=3.0V (Ta= 40°C) and not 100% tested.
  - 3. BYTE# pin is supported by only 52-pin µTSOP type.
  - 4. Also CS2 controls address buffer, WE# buffer ,CS1# buffer ,OE# buffer ,LB# ,UB# buffer and Din buffer .If CS2 controls data retention mode,Vin levels (address, WE# ,OE#,CS1#,LB#,UB#,I/O) can be in the high impedance state. If CS1# controls data retention mode, CS2 must be CS2 ≥ Vcc-0.2V or 0V ≤ CS2 ≤ 0.2V. The other input levels (address, WE# ,OE#,CS1#,LB#,UB#,I/O) can be in the high impedance state.

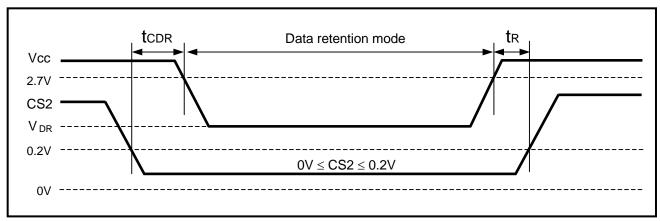


### Low Vcc Data Retention Timing Waveform (1) (CS1# Controlled)



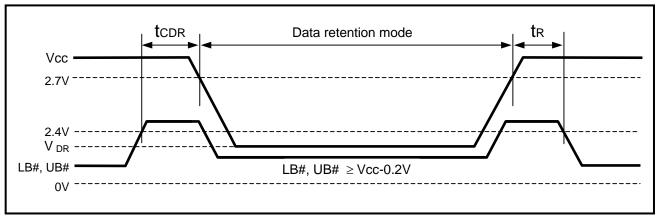
Note: BYTE# pin is supported by only 52-pin  $\mu$ TSOP type. BYTE#  $\geq$  Vcc-0.2V or BYTE#  $\leq$  0.2V

### Low Vcc Data Retention Timing Waveform (2) (CS2 Controlled)



Note: BYTE# pin is supported by only 52-pin  $\mu$ TSOP type. BYTE#  $\geq$  Vcc-0.2V or BYTE#  $\leq$  0.2V

## Low Vcc Data Retention Timing Waveform (3) (LB#, UB# Controlled)



Note: BYTE# pin is supported by only 52-pin  $\mu$ TSOP type. BYTE#  $\geq$  Vcc-0.2V or BYTE#  $\leq$  0.2V



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